MARKING

1-of-8 Decoder/Demultiplexer

MC74AC138, MC74ACT138

The MC74AC138/74ACT138 is a high-speed 1-of-8 decoder/demultiplexer. This device is ideally suited for high-speed bipolar memory chip select address decoding.

The multiple input enables allow parallel expansion to a 1–of–24 decoder using just three MC74AC138/74ACT138 devices or a 1–of–32 decoder using four MC74AC138/74ACT138 devices and one inverter.

- Demultiplexing Capability
- Multiple Input Enable for Easy Expansion
- Active LOW Mutually Exclusive Outputs
- Outputs Source/Sink 24 mA
- 'ACT138 Has TTL Compatible Inputs
- These are Pb–Free Devices



Figure 1. Pinout: 16-Lead Packages Conductors (Top View)

					ļ	ļ		
A ₀	A ₁	A ₂			E ₁	E ₂	E ₃	
O ₀	0 ₁	0 ₂	0 ₃	04	0 ₅	0 ₆	07	
ſ	ſ	ſ	ſ	ſ	ſ	Ŷ	ſ	_

Figure 2. Logic Symbol

PIN ASSIGNMENT

PIN	FUNCTION
A ₀ -A ₂	Address Inputs
$\overline{E}_1 - \overline{E}_2$	Enable Inputs
E ₃	Enable Input
$\overline{O}_0 - \overline{O}_7$	Outputs



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

FUNCTIONAL DESCRIPTION

The MC74AC138/74ACT138 high-speed 1-of-8 decoder/demultiplexer accepts three binary weighted inputs (A₀, A₁, A₂) and, when enabled, provides eight mutually exclusive active-LOW outputs (\overline{O}_0 - \overline{O}_7). The MC74AC138/74ACT138 features three Enable inputs, two active-LOW (\overline{E}_1 , \overline{E}_2) and one active-HIGH (E₃). All outputs will be HIGH unless \overline{E}_1 and \overline{E}_2 are LOW and E_3 is

HIGH. This multiple enabled function allows easy parallel expansion of the device to a 1–of–32 (5 lines to 32 lines) decoder with just four MC74AC138/74ACT138 devices and one inverter (See Figure 4). The MC74AC138/74ACT138 can be used as an 8–output demultiplexer by using one of the active LOW Enable inputs as the data input and the other Enable inputs as strobes. The Enable inputs which are not used must be permanently tied to their appropriate active–HIGH or active–LOW state.

TRUT	TRUTH TABLE												
	Inputs					Outputs							
\overline{E}_1	\overline{E}_2	E ₃	A ₀	A ₁	A ₂	\overline{O}_0	\overline{O}_1	\overline{O}_2	\overline{O}_3	\overline{O}_4	\overline{O}_5	\overline{O}_6	\overline{O}_7
H X X	X H X	X X L	X X X	X X X	X X X	H H H	H H H	H H H	нн	H H H	H H H	H H H	нн
L L L	L L L	Н Н Н	L H L H	L L H H	L L L	L H H	H L H H	H H L H	H H L	H H H	H H H	H H H	ннн
L L L		тттт	ーエーエ		тттт	тттт	тттт	тттт	тттт	ーエエエ	エーエエ	エエーエ	H H H L

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial



NOTE: This diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Figure 3. Logic Diagram



Figure 4. Expansion to 1-of-32 Decoding

MAXIMUM RATINGS

Symbol	Parameter		Value	Unit
V _{CC}	DC Supply Voltage		-0.5 to +6.5	V
VI	DC Input Voltage		$-0.5\leqV_{I}\leqV_{CC}+0.5$	V
Vo	DC Output Voltage	(Note 1)	$-0.5 \leq V_O \leq V_{CC} + 0.5$	V
I _{IK}	DC Input Diode Current		±20	mA
I _{OK}	DC Output Diode Current		±50	mA
I _O	DC Output Sink/Source Current		±50	mA
I _{CC}	DC Supply Current per Output Pin		±50	mA
I _{GND}	DC Ground Current per Output Pin		±50	mA
T _{STG}	Storage Temperature Range		-65 to +150	°C
TL	Lead temperature, 1 mm from Case for 10 Seconds		260	°C
TJ	Junction temperature under Bias		+ 150	°C
θ_{JA}	Thermal Resistance (Note 2)	SOIC TSSOP	126 159	°C/W
P _D	Power Dissipation in Still Air at 25°C (Note 3)	SOIC TSSOP	995 787	mW
MSL	Moisture Sensitivity		Level 1	
F _R	Flammability Rating Oxygen Index: 30% – 35%		UL 94 V-0 @ 0.125 in	
V _{ESD}		/ Model (Note 4) e Model (Note 5)	> 2000 > 1000	V
I _{Latch-Up}	Latch-Up Performance Above V _{CC} and Below GND	at 85°C (Note 6)	±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. I_O absolute maximum rating must be observed.

2. The package thermal impedance is calculated in accordance with JESD51-7.

3. 500 mW at 65°C; derate to 300 mW by 10 mW/ from 65°C to 85°C.

4. Tested to EIA/JESD22-A114-A.

5. Tested to JESD22-C101-A.

6. Tested to EIA/JESD78.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Тур	Max	Unit		
		′AC	2.0	5.0	6.0		
V _{CC}	Supply Voltage	′ACT	4.5	5.0	5.5	V	
V _{IN} , V _{OUT}	DC Input Voltage, Output Voltage (Ref. to GND)			-	V _{CC}	V	
t _r , t _f		V _{CC} @ 3.0 V	-	150	-		
	Input Rise and Fall Time (Note 1) 'AC Devices except Schmitt Inputs	V _{CC} @ 4.5 V	-	40	-	ns/V	
		V _{CC} @ 5.5 V	-	25	-		
	Input Rise and Fall Time (Note 2)	V _{CC} @ 4.5 V	-	10	-	ns/V	
t _r , t _f	ACT Devices except Schmitt Inputs	V _{CC} @ 5.5 V	-	8.0	-		
T _A	Operating Ambient Temperature Range			25	85	°C	
I _{OH}	Output Current – High			-	-24	mA	
I _{OL}	Output Current – Low			-	24	mA	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability. 1. V_{IN} from 30% to 70% V_{CC} ; see individual Data Sheets for devices that differ from the typical input rise and fall times. 2. V_{IN} from 0.8 V to 2.0 V; see individual Data Sheets for devices that differ from the typical input rise and fall times.

DC CHARACTERISTICS

			74	AC	74AC			
Symbol	Parameter	V _{CC} (V)	T _A =	+25°C	T _A = –40°C to +85°C	Unit	Conditions	
			Тур	Typ Guaranteed Limits				
V _{IH}	Minimum High Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	2.1 3.15 3.85	2.1 3.15 3.85	v	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$	
V _{IL}	Maximum Low Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	0.9 1.35 1.65	0.9 1.35 1.65	v	$V_{OUT} = 0.1 V$ or V _{CC} – 0.1 V	
V _{OH}	Minimum High Level Output Voltage	3.0 4.5 5.5	2.99 4.49 5.49	2.9 4.4 5.4	2.9 4.4 5.4	v	I _{OUT} = -50 μA	
		3.0 4.5 5.5	- - -	2.56 3.86 4.86	2.46 3.76 4.76	v	$V_{IN} = V_{IL} \text{ or } V_{IH}$ -12 mA I_{OH} -24 mA -24 mA	
V _{OL}	Maximum Low Level Output Voltage	3.0 4.5 5.5	0.002 0.001 0.001	0.1 0.1 0.1	0.1 0.1 0.1	v	I _{OUT} = 50 μA	
		3.0 4.5 5.5	- - -	0.36 0.36 0.36	0.44 0.44 0.44	v	$V_{IN} = V_{IL} \text{ or } V_{IH}$ 12 mA I_{OL} 24 mA 24 mA	
I _{IN}	Maximum Input Leakage Current	5.5	-	±0.1	±1.0	μΑ	V _I = V _{CC} , GND	
I _{OLD}	†Minimum Dynamic	5.5	-	-	75	mA	V _{OLD} = 1.65 V Max	
I _{OHD}	Output Current	5.5	-	-	-75	mA	V _{OHD} = 3.85 V Min	
I _{CC}	Maximum Quiescent Supply Current	5.5	_	8.0	80	μA	$V_{IN} = V_{CC}$ or GND	

*All outputs loaded; thresholds on input associated with output under test. †Maximum test duration 2.0 ms, one output loaded at a time.

NOTE: I_{IN} and I_{CC} @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V_{CC}.

AC CHARACTERISTICS

	Parameter			74AC		74	AC	
Symbol			T _A = +25°C C _L = 50 pF			T _A = −40°C to +85°C C _L = 50 pF		Unit
			Min	Тур	Max	Min	Max	
t _{PLH}	Propagation Delay A_n to \overline{O}_n	3.3 5.0	1.5 1.5	8.5 6.5	13.0 9.5	1.5 1.5	15.0 10.5	ns
t _{PHL}	Propagation Delay A_n to \overline{O}_n	3.3 5.0	1.5 1.5	8.0 6.0	12.5 9.0	1.5 1.5	14.0 10.5	ns
t _{PLH}	Propagation Delay $\overline{E}_1 \text{ or } \overline{E}_2 \text{ to } \overline{O}_n$	3.3 5.0	1.5 1.5	11.0 8.0	15.0 11.0	1.5 1.5	16.0 12.0	ns
t _{PHL}	Propagation Delay $E_1 \text{ or } E_2 \text{ to } \overline{O}_n$	3.3 5.0	1.5 1.5	9.5 7.0	13.5 9.5	1.5 1.5	15.0 10.5	ns
t _{PLH}	Propagation Delay E_3 to \overline{O}_n	3.3 5.0	1.5 1.5	11.0 8.0	15.5 11.0	1.5 1.5	16.5 12.5	ns
t _{PHL}	Propagation Delay E_3 to \overline{O}_n	3.3 5.0	1.5 1.5	8.5 6.0	13.0 8.0	1.5 1.0	14.0 9.5	ns

*Voltage Range 3.3 V is 3.3 V ± 0.3 V. *Voltage Range 5.0 V is 5.0 V ± 0.5 V.

DC CHARACTERISTICS

			744	СТ	74ACT			
Symbol	Parameter	V _{CC} (V)	T _A = -	+25°C	T _A = -40°C to +85°C	Unit	Conditions	
			Тур	Gua	aranteed Limits			
V _{IH}	Minimum High Level Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0 2.0	v	V_{OUT} = 0.1 V or V _{CC} – 0.1 V	
V _{IL}	Maximum Low Level Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8 0.8	v	V_{OUT} = 0.1 V or V _{CC} – 0.1 V	
V _{OH}	Minimum High Level Output Voltage	4.5 5.5	4.49 5.49	4.4 5.4	4.4 5.4	v	I _{OUT} = -50 μA	
		4.5 5.5		3.86 4.86	3.76 4.76	v	$V_{IN} = V_{IL} \text{ or } V_{IH}$ -24 mA I_{OH} -24 mA	
V _{OL}	Maximum Low Level Output Voltage	4.5 5.5	0.001 0.001	0.1 0.1	0.1 0.1	v	I _{OUT} = 50 μA	
		4.5 5.5		0.36 0.36	0.44 0.44	v	$V_{IN} = V_{IL} \text{ or } V_{IH}$ 24 mA I_{OL} 24 mA	
I _{IN}	Maximum Input Leakage Current	5.5	-	±0.1	±1.0	μA	V _I = V _{CC} , GND	
ΔI_{CCT}	Additional Max. I _{CC} /Input	5.5	0.6	-	1.5	mA	V _I = V _{CC} – 2.1 V	
I _{OLD}	†Minimum Dynamic	5.5	-	-	75	mA	V _{OLD} = 1.65 V Max	
I _{OHD}	Output Current	5.5	-	-	-75	mA	V _{OHD} = 3.85 V Min	
I _{CC}	Maximum Quiescent Supply Current	5.5	_	8.0	80	μA	V _{IN} = V _{CC} or GND	

*All outputs loaded; thresholds on input associated with output under test. †Maximum test duration 2.0 ms, one output loaded at a time.

AC CHARACTERISTICS

	Parameter	V _{CC} * (V)	74ACT T _A = +25°C C _L = 50 pF			74 <i>4</i>	Unit	
Symbol						T _A = -40°C C _L = 5		
			Min	Тур	Max	Min	Max	
t _{PLH}	Propagation Delay A_n to \overline{O}_n	5.0	1.5	7.0	10.5	1.5	11.5	ns
t _{PHL}	Propagation Delay A_n to \overline{O}_n	5.0	1.5	6.5	10.5	1.5	11.5	ns
t _{PLH}	Propagation Delay \overline{E}_1 or \overline{E}_2 to \overline{O}_n	5.0	2.5	8.0	11.5	2.0	12.5	ns
t _{PHL}	Propagation Delay \overline{E}_1 or \overline{E}_2 to \overline{O}_n	5.0	2.0	7.5	11.5	2.0	12.5	ns
t _{PLH}	Propagation Delay $E_{3 to} \overline{O}_n$	5.0	2.5	8.0	12.0	2.0	13.0	ns
t _{PHL}	Propagation Delay E_3 to \overline{O}_n	5.0	2.0	6.5	10.5	1.5	11.5	ns

*Voltage Range 5.0 V is 5.0 V \pm 0.5 V

CAPACITANCE

Symbol	Parameter	Value Typ	Unit	Test Conditions
C _{IN}	Input Capacitance	4.5	pF	V _{CC} = 5.0 V
C _{PD}	Power Dissipation Capacitance	60	pF	V _{CC} = 5.0 V

ORDERING INFORMATION

Device Order Number	Marking	Package	Shipping [†]
MC74AC138DG	AC138	SOIC-16 (Pb-Free)	48 Units / Rail
MC74AC138DR2G	AC138	SOIC-16 (Pb-Free)	2500 Tape & Reel
MC74AC138DTR2G	AC 138	TSSOP-16 (Pb-Free)	2500 Tape & Reel
MC74ACT138DG	ACT138	SOIC-16 (Pb-Free)	48 Units / Rail
MC74ACT138DR2G	ACT138	SOIC-16 (Pb-Free)	2500 Tape & Reel
MC74ACT138DR2G-Q*	ACT138	SOIC-16 (Pb-Free)	2500 Tape & Reel
MC74ACT138DTR2G	ACT 138	TSSOP-16 (Pb-Free)	2500 Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
 *-Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP

Capable.

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SOIC-16 9.90x3.90x1.50 1.27P CASE 751B ISSUE L

DATE 29 MAY 2024

DURSEM

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. DIMENSION IN MILLIMETERS. ANGLE IN DEGREES.
- 3. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD PROTRUSION.
- 4. MAXIMUM MOLD PROTRUSION 0.15mm PER SIDE.
- DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127mm TOTAL IN EXCESS OF THE b DIMENSION AT MAXIMUM MATERIAL CONDITION.







DIM	MIN	NOM MAX							
A	1.35	1.55	1.75						
A1	0.00	0.05	0.10						
A2	1.35	1.50	1.65						
b	0.35	0.42	0.49						
с	0.19	0.22	0.25						
D		9.90 BSC							
E	6.00 BSC								
E1	3.90 BSC								
е	1.27 BSC								
h	0.25		0.50						
L	0.40	0.83	1.25						
L1		1.05 REF							
Θ	0.		7'						
TOLERAN	TOLERANCE OF FORM AND POSITION								
aaa	0.10								
bbb		0.20							
ccc	0.10								
ddd		0.25							
eee		0.10							

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DATE 29 MAY 2024

GENERIC MARKING DIAGRAM*

16	F	A	H	A	H	A	A	A	
		XX							
		XX	XX)	XX	XX)	XX	XX	X	
	O AWLYWW								
1	Ŧ	H	H	H	H	H	H	Ŧ	I

XXXXX = Specific Device Code

A = Assembly Location

- WL = Wafer Lot
- Y = Year
- WW = Work Week
- G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1:		STYLE 2:		STYLE 3:		STYLE 4:	
PIN 1.	COLLECTOR	PIN 1.	CATHODE	PIN 1.		PIN 1.	COLLECTOR, DYE #1
2.	BASE	2.	ANODE	2.	BASE, #1	2.	
3.	EMITTER	3.	NO CONNECTION	3.	EMITTER, #1	3.	
4.	NO CONNECTION	4.	CATHODE	4.		4.	
5.	EMITTER	5.	CATHODE	5.	COLLECTOR, #2	5.	
6.	BASE	6.	NO CONNECTION	6.	BASE, #2	6.	COLLECTOR, #3
7.	COLLECTOR	7.	ANODE	7.	EMITTER, #2	7.	
8.	COLLECTOR	8.	CATHODE	8.	COLLECTOR, #2	8.	COLLECTOR, #4
9.	BASE	9.	CATHODE	9.	COLLECTOR, #3	9.	BASE, #4
10.	EMITTER	10.	ANODE	10.	BASE, #3	10.	EMITTER, #4
11.	NO CONNECTION	11.	NO CONNECTION	11.	EMITTER, #3	11.	BASE, #3
12.	EMITTER	12.	CATHODE	12.	COLLECTOR, #3	12.	EMITTER, #3
13.	BASE	13.	CATHODE	13.	COLLECTOR, #4	13.	BASE, #2
14.	COLLECTOR	14.	NO CONNECTION	14.	BASE, #4	14.	EMITTER, #2
15.	EMITTER	15.	ANODE	15.	EMITTER, #4	15.	BASE, #1
16.	COLLECTOR	16.	CATHODE	16.	COLLECTOR, #4	16.	EMITTER, #1
STYLE 5:		STYLE 6:		STYLE 7:			
PIN 1.	DRAIN, DYE #1	PIN 1.	CATHODE	PIN 1.	SOURCE N-CH		
2.	DRAIN, #1	2.	CATHODE	2.	COMMON DRAIN (OUTPUT)	
3.	DRAIN, #2	3.	CATHODE	3.	COMMON DRAIN (OUTPUT)	
4.	DRAIN, #2	4.	CATHODE	4.	GATE P-CH		
5.	DRAIN, #3	5.	CATHODE	5.	COMMON DRAIN (OUTPUT)	
6.	DRAIN, #3	6.	CATHODE	6.	COMMON DRAIN (OUTPUT)	
7.	DRAIN, #4	7.	CATHODE	7.	COMMON DRAIN (OUTPUT)	
8.	DRAIN, #4	8.	CATHODE	8.	SOURCE P-CH		
9.	GATE, #4	9.	ANODE	9.	SOURCE P-CH		
10.	SOURCE, #4	10.	ANODE	10.	COMMON DRAIN (OUTPUT)	
11.	GATE, #3	11.	ANODE	11.	COMMON DRAIN (OUTPUT)	
12.	SOURCE, #3	12.	ANODE	12.)	
13.	GATE, #2		ANODE	13.			
14.	SOURCE, #2		ANODE	14.			
15.	GATE, #1	15.	ANODE	15.)	
16.	SOURCE, #1	16.	ANODE	16.	SOURCE N-CH		

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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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